

RX Family

APPLICATION NOTE

R01AN2293EJ0120 Rev.1.20 Jun 1, 2020

Sample Program using USB Host Communication Device Class Driver(HCDC) for USB Mini Firmware to communicate via USB with CDC device Firmware Integration Technology

Introduction

This document describes the following sample firmware: USB Host Communication Devices Class Driver using Firmware Integration Technology. The sample firmware is referred to below as the HCDC.

When developing an actual software, be sure to use the "USB Basic Mini Host and Peripheral Driver (USB Mini Firmware) using Firmware Integration Technology Application Note" (Document number: R01AN2166) together with the user's manual for each MCU (Hardware). In addition, also refer to the "USB Host Communication Device Class Driver (HCDC) for USB Mini Firmware using Firmware Integration Technology Application Note" (Document number:R01AN2167), if necessary. "USB Basic Mini Host and Peripheral Driver (USB Mini Firmware) using Firmware Integration Technology Application Note" (Document number: R01AN2167), if necessary. "USB Basic Mini Host and Peripheral Driver (USB Mini Firmware) using Firmware Integration Technology Application Note" (Document number: R01AN2166) is located in the "reference_documents" folder within the package.

Target Device

RX111 Group RX113 Group RX231 Group RX23W Group

The operation of this program has been confirmed using the Renesas Starter Kits (RSK) or the Renesas Solution Starter Kit (RSSK).

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1. Introduction

1.1 Functions

The HCDC conforms to the Abstract Control Model of the USB communication device class (CDC) specification and implements communication with CDC devices.

The HCDC provides the following functionality:

• Performs communication class data transfer when a CDC device is connected.

1.2 FIT Module Configuration

The HCDC comprises the following FIT modules and a sample application:

Table 1-1 FIT Module Configuratio

FIT Module	Folder Name
RX Family Board Support Package Module	r hen
Using Firmware Integration Technology	r_bsp
RX Family USB Basic Mini Host and Peripheral Driver (USB Mini Firmware) using Firmware Integration Technology	r_usb_basic_mini
RX Family USB Host Communication Devices Class Driver (CDC) for USB Mini Firmware using Firmware Integration Technology	r_usb_hcdc_mini
RX Family DTC Module Using Firmware Integration Technology	r_dtc_rx
RX Family DMA Controller DMACA Control Module Firmware Integration Technology	r_dmaca_rx

Refer to the related documentation for details of each FIT module. Note that the latest versions of the FIT modules used by the sample firmware are available for download from the following website:

Renesas Electronics website: http://www.renesas.com/

1.3 Note

This driver is not guaranteed to provide USB communication operation. The customer should verify operation when utilizing it in a system and confirm the ability to connect to a variety of different types of devices.

1.4 Operating Confirmation Environment

The operating confirmation environment for the HCDC is described below:

Item	Contents
C compiler	Renesas Electronics C/C++ compiler for RX Family V.3.02.00 (The option "-lang=C99" is added to the default setting of IDE)
	GCC for Renesas RX 8.3.0.201904
	(The option "-std=gnu99" is added to the default setting of IDE)
	IAR C/C++ Compiler for Renesas RX version 4.14.1
Real-Time OS	FreeRTOS V.10.0.0
	RI600V4 V.1.06
Endian	Little Endian, Big Endian
USB Driver Revision Number	Rev.1.20
Using Board	Renesas Starter Kit for RX111
	Renesas Starter Kit for RX113
	Renesas Starter Kit for RX231
	Renesas Solution Starter Kit for RX23W

Table 1-2	Operation Confirmation Environment
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2. Software Configuration

2.1 Module Configuration

The HCDC transfers data to and from a device via the HCD and reports the results to the APL. Also, it reports data transfer requests from the APL to devices via HCDC and HCD.

Figure 2-1 shows the module configuration of the HCDC, and Table 2-1 lists the functions of the modules.

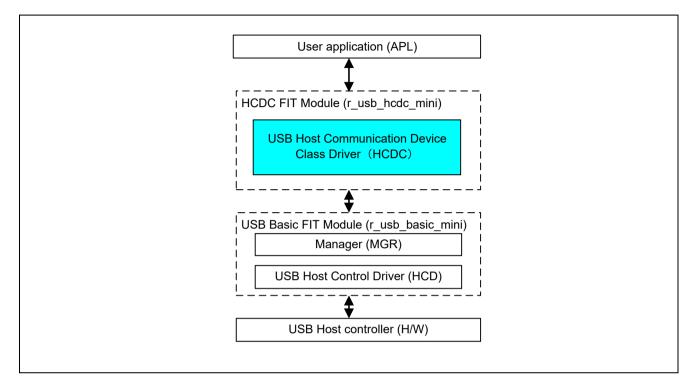


Figure 2-1 Module Configuration

Table 2-1 Functions of Module	es
-------------------------------	----

Module Name	Function
APL	Sample application program
HCDC (r_usb_hcdc_mini)	CDC Class Driver
	Sends CDC-related requests from the APL and data transfer requests to the HCD.
HCD (r_usb_basic_mini)	USB Host Control Driver



3. Setup

3.1 Hardware

3.1.1 Example Operating Environment

Figure 3-1 shows an example operating environment for the HCDC. Refer to the associated instruction manuals for details on setting up the evaluation board and using the emulator, etc.

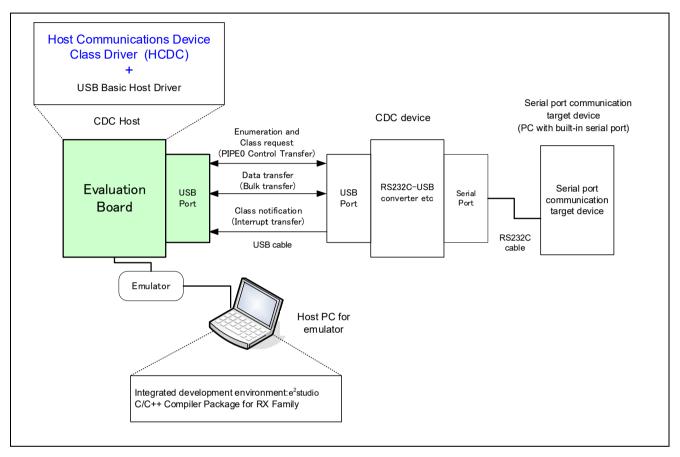


Figure 3-1 Example Operating Environment

Table 3-1 shows the evaluation board on which operation has been confirmed.

MCU	Evalulation Board
RX111	RSKRX111
RX113	RSKRX113
RX231	RSKRX231
RX23W	RSSKRX23W

Table 3-1 Evaluation Board on which HCDC Operation Has Been Verified

3.1.2 RSK / RSSK Setting

It is necessary to set RSK/RSSK to operate in the host mode. Please refer to the following.

Table 3-2**RSK / RSSK Setting**

RSK / RSSK	Jumper Setting
RSKRX111	J12: Shorted Pin1-2
RSKRX113	J12: Shorted Pin1-2
RSKRX231	J15: Shorted Pin1-2
RSSKRX23W	J5: Shorted Pin2-3

Note:

For the detail of RSK/RSSK setting, refer to the user's manual of RSK/RSSK.



3.2 Software

- 1) Setup e² studio
 - a) Start e² studio
 - b) If you start up e² studio at first, the following dialog is displayed. Specify the folder to store the project in this dialog.

e ² Eclipse Launcher				×
Select a directory as workspace e2 studio uses the workspace directory to store its preferences and developmen	it artifact:	s.		
<u>W</u> orkspace:		~	<u>B</u> rowse	
Use this as the default and do not ask again	OK		Cancel	

- 2) Import the project to the workspace
 - a) Select [File] > [Import]
 - b) Select [General] => [Existing Projects into Workspace]

e ² Import -		×
Select Create new projects from an archive file or directory.	Ľ	1
Select an import wizard:		
type filter text		
 ✓ ➢ General 		^

c) Select the root directory of the project, that is, the folder containing the ".cproject" file.

e ² Import			×
Import Projects Select a directory to search for existing Eclipse projects.			
Select roo <u>t</u> directory: Select <u>a</u> rchive file:	×	B <u>r</u> ows	
Projects:			
		<u>S</u> elect	All
		<u>D</u> eselect	t All
		R <u>e</u> fres	sh

d) Click "Finish".

You have now imported the project into the workspace. Note that you can import other projects into the same workspace.

- 3) Generate the binary target program by clicking the "Build" button.
- 4) Connect the target board to the debug tool and download the executable. The target is run by clicking the "Run" button.



4. Sample Application

4.1 Application Specifications

The main functions of the APL are as follows:

- 1. Sends receive (Bulk In transfer) requests to the CDC device and receives data.
- 2. Transfers received data to the CDC device by means of Bulk Out transfers (loopback).
- 3. The communication speed and other settings are made by transmitting the class request *SET_LINE_CODING* to the CDC device. This class request can be used to set the communication speed, number of data bits, number of stop bits, and the parity bit.

4.1.1 Data Transfer Image

Figure 4-1 shows the data transfer image.

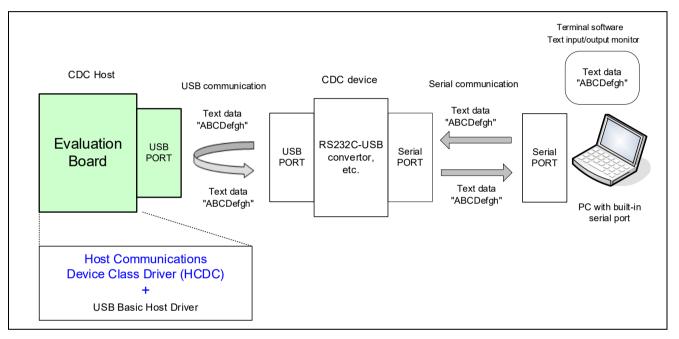


Figure 4-1 Data Transfer (Loopback) Image



4.2 Application Processing

The application comprises two parts: initial settings and main loop. An overview of the processing in these two parts is provided below.

4.2.1 Initial setting

Initial settings consist of MCU pin settings, USB driver settings, and initial settings to the USB controller.

4.2.2 Main Loop (Non-OS)

The main loop performs loop-back processing in which data received from the CDC device is transmitted unaltered back to the CDC device as part of the main routine. An overview of the processing of the main loop is presented below.

- 1. When the *R_USB_GetEvent* function is called after the CDC device attaches to the RSK/RSSK and enumeration completes, *USB_STS_CONFIGURED* is set as the return value. When the APL confirms *USB_STS_CONFIGURED*, it sends class request *SET_LINECODING* to the CDC device.
- 2. When it confirms that the class request processing has completed, the APL calls the *R_USB_Read* function to make a data receive request for data sent from the CDC device. Note that in addition to the data receive request a receive request is also sent for a class notification from the CDC device.
- 3. When the *R_USB_GetEvent* function is called after reception of data from the CDC device has completed, *USB_STS_READ_COMPLETE* is set as the return value. The received data is stored in external variable *g_data*. The receive data size can be confirmed by means of the size member of the usb_ctrl_t structure. The APL determines that a null packet has been received if the value of the size member is 0 (zero) and performs another data receive request. If the value of the size member is other than 0 (zero), the APL determines that data has been received from the CDC device. It then makes a transmit request to send the received data to the CDC device.
- 4. When the *R_USB_GetEvent* function is called after transmission of data to the CDC device completes, *USB_STS_WRITE_COMPLETE* is set as the return value. When the APL confirms *USB_STS_WRITE_COMPLETE*, it calls the R_USB_Read function to make a data receive request for data sent by the CDC device.
- 5. The processing in steps 3 and 4, above, is repeated.



An overview of the processing performed by the APL is shown below:

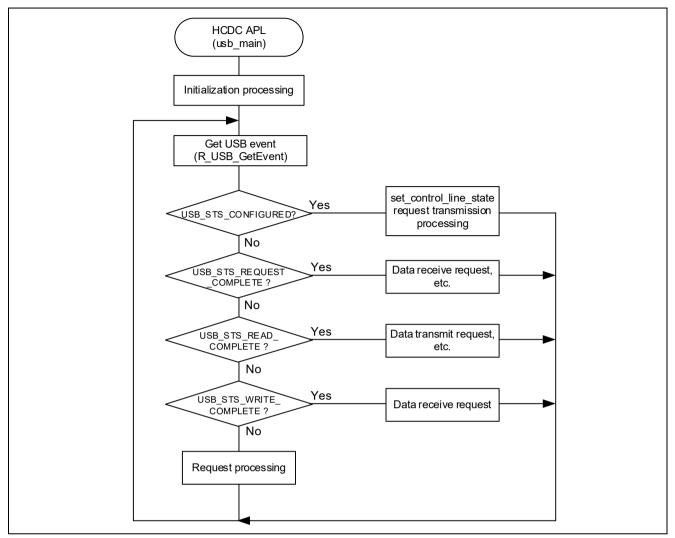


Figure 4-2 Main Loop processing (for Non-OS)

4.2.3 Main Loop (for RTOS)

The loop performs loop-back processing in which data received from the CDC device is transmitted unaltered back to the CDC device as part of the main routine. An overview of the processing performed by the loop is shown below.

- 1. When a USB-related event has completed, the USB driver calls the callback function (*usb_apl_callback*). In the callback function (*usb_apl_callback*), the application task (APL) is notified of the USB completion event using the real-time OS functionality.
- 2. In APL, information regarding the USB completion event was notified from the callback function is retrieved using the real-time OS functionality.
- 3. If the USB completion event (the *event* member of the *usb_ctrl_t* structure) retrieved in step 2 above is *USB_STS_CONFIGURED*, APL sends the class request (*SET_LINECODING*) to the CDC device.
- 4. If the USB completion event (the *event* member of the *usb_ctrl_t* structure) retrieved in step 2 above is *USB_STS_REQUEST_COMPLETE*, APL performs a data reception request to receive data transmitted from the CDC device by calling the *R_USB_Read* function and also performs a class notification reception request from CDC device.
- 5. If the USB completion event (the *event* member of the *usb_ctrl_t* structure) retrieved in step 2 above is *USB_STS_READ_COMPLETE*, APL performs a data transmission request to send the reception data by calling the *R_USB_Write* function. The reception data is stored in the gloval variable (*g_data*). The reception data size



is set in the member (*size*) of the *usb_ctrl_t* structure. If this member (*size*) is zero, the USB driver judges that the *NULL* packet is received and performs a data reception request to the CDC device again.

- 6. If the USB completion event (the *event* member of the *usb_ctrl_t* structure) retrieved in step 2 above is *USB_STS_WRITE_COMPLETE*, APL performs a data reception request to receive the data sent from CDC device.
- 7. The avove processing is repeated.

An overview of the processing performed by the APL is shown below:

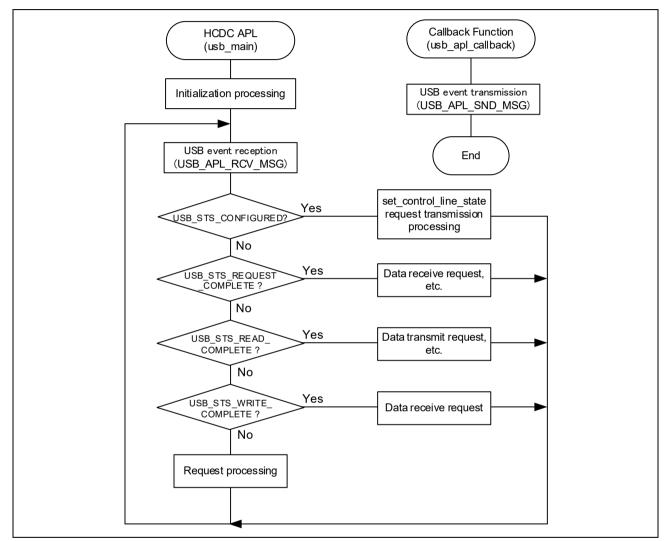


Figure 4-3 Main Loop processing (for RTOS)



4.3 Configuration File for the application program (r_usb_hcdc_apl_config.h)

Make settings for the definitions listed below.

1. COM_SPEED Definition

Please specify the baud rate value. This baud rate value is set to the CDC device by the class request (*SET_LINE_CODING*). Specify a setting of *BPS_9600 / BPS_14400 / BPS_19200 / BPS_38400 / BPS_57600 / BPS_115200* to *COM_SPEED* definition.

#define COM_SPEED BPS_57600 // Baud rate value

2. COM_PARITY_BIT Definition

Please specify the parity bit. This parity bit is set to the CDC device by the class request (*SET_LINE_CODING*). Specify a setting of *PARITY_EVEN / PARITY_ODD / PARITY_NONE* to *COM_PARITY_BIT* definition.

#define COM_PARITY_BIT PARITY_NONE // Parity bit

3. COM_STOP_BIT Definition

Please specify the stop bit. This stop bit is set to the CDC device by the class request (*SET_LINE_CODING*). Specify a setting of *STOP_BIT1*(1 bit) / *STOP_BIT15*(1.5 bit) / *STOP_BIT2*(2 bit) to *COM_STOP_BIT* definition.

#define COM_STOP_BIT STOP_BIT1 // Stop bit

4. COM_DATA_BIT Definition

Please specify the data bit. This data bit is set to the CDC device by the class request (*SET_LINE_CODING*). Specify a setting of *DATA_BIT7*(7 bit) / *DATA_BIT8*(8 bit) to *COM_DATA_BIT* definition.

#define COM_DATA_BIT DATA_BIT8 // Data bit

5. USB_SUPPORT_RTOS Definition

Please specify USB APL ENABLE to USB SUPPORT RTOS definition when using the real-time OS.

#define	USB_SUPPORT_RTOS	USB_APL_DISABLE	// No use the real-time OS
#define	USB_SUPPORT_RTOS	USB_APL_ENABLE	// Use the real-time OS

6. Note

The above configuration settings apply to the application program. USB driver configuration settings are required in addition to the above settings. For information on USB driver configuration settings, refer to the application note USB Basic Mini Host and Peripheral Driver (USB Mini Firmware) using Firmware Integration Technology (Document number. R01AN2166).



5. Class Driver Overview

5.1 Class Request

Table 5-1 shows the class requests supported by HCDC.

Table 5-1 Supported Basic Requests and CDC Class Requests

Request	Code	Description	Suppoted
SendEncapsulatedCommand	0x00	Sends protocol-defined commands such as AT.	YES
GetEncapsulatedResponse	0x01	Requests response to command sent in SendEncapsulatedCommand.	YES
SetCommFeature	0x02	Sets enable/disable for device-specific 2-byte code and country code.	YES
GetCommFeature	0x03	Sets enable/disable for device-specific 2-byte code and country code.	YES
ClearCommFeature	0x04	Returns enable/disable status for device-specific 2-byte code and country code to default settings.	YES
SetLineCoding	0x20	Sets transmission line coding (transmission speed, data length, parity bit, stop bit length)	YES
GetLineCoding	0x21	Obtains transmission line coding status.	YES
SetControlLineState	0x22	Sets control signals RTS and DTR for transmission line.	YES
SendBreak	0x23	Sends break signal.	YES

5.2 Class Notification (Notification from CDC device to USB Host)

 Table 5-2 shows class notifications supported by the HCDC.

Table 5-2 CDC Class Specific Notification

Notification	Code	Description	Supported
NETWORK_CONNECTION	0x00	Notifies network connection state.	NO
RESPONSE_AVAILABLE	0x01	Response to GET_ENCAPSLATED_RESPONSE.	NO
SERIAL_STATE	0x20	Notifies serial line status.	YES



6. Using RI600V4 project with CS+

The RI600V4 project in the package does not support CS+. The user needs to create a project for CS+ according to the following procedure when using RI600V4 project on CS+.

6.1 New Project Creation

Select "Application(RI600V4, CC-RX) for the Kind of project.

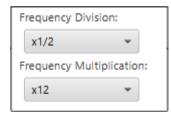
Create Project					
Microcontroller: RX				~	
Using microcontroller:					
(Search microcontroller)		<u>U</u> pdate			
R5F52318BxFL(48pin) R5F52318BxFM(64pin) R5F52318BxFP(100pin) R5F52318BxLA(100pin) R5F52318BxND(64pin) R5F52318BxND(64pin) R5F52318BxND(64pin) R5F52318BxNL(48pin) R5F52318BxNL(48pin) R5F52318BxNL(48pin) RX23E-A RX23T RX23T		On-chip ROM size[On-chip RAM size[Additional Informati	KBytes]:512	100KB-A	
Kind of project: Application(RI600		00V4,CC-RX)		~	
Project name: nx_usb					
Place: D:\RX			\checkmark	B <u>r</u> owse	

6.2 Launch Smart Configurator

1. Clock Setting (Select "Clocks" tab)

Set the related clock so that "48MHz" is set to UCLK (USB clock).

The following is a setting example when using the oscillator(8MHz).



2. Component Setting (Select "Components" tab)

(1). Import the USB FIT module

Select the *r_usb_hcdc_mini* module and press the "Finish" button. The *r_usb_basic_mini* module is imported at the same time.

Note:

Select the r_dtc_rx / r_dmaca_rx module when using the DTC/DMA.



e ² New Co	e² New Component — 🗆 🗙						
	Software Component Selection Select component from those available in list						
Туре							
Function	Function All ~						
Compor	nents	Туре	Version	,	^		
🖶 r_bsp		FIT	5.50				
tr_cmt	tr_cmt_rx		4.30				
🖶 r_usb	_basic_mini	FIT	1.20				
🖶 r_usb	🖶 r_usb_hcdc_mini		1.20				
🖶 r_usb	_hhid_mini	FIT	1.20	_			
or_usb_hmsc_mini		FIT	1.20				
🖶 r_usb	_pcdc_mini	FIT	1.20				
🖶 r_usb	_phid_mini	FIT	1.20				
🖶 r_usb	_pmsc_mini	FIT	1.20				

(2). Configuration Setting

a. r_bsp

Change the heap size when using DTC transfer. For the setting value, refer to the documentation for DTC FIT module.

b. r_usb_basic_mini

🛱 *rx_usb.scfg 🖾		
Software component configuration		
Components $\downarrow^{a}_{Z} \models \Rightarrow \checkmark$	Configure	
type filter text	Property	Value
 ✓		
 ✓ ➢ Drivers ✓ ➢ Communications ♂ r_usb_basic_mini 		

(a). Configurations

Set each item according to the user system. For the detail of each item, refer to chapter "Configuration" in USB Basic Mini Host and Peripheral Driver Firmware Integration Technology application note (Document number: R01AN2166).

(b). Resources

Check the following check box.

- i. USBx_VBUSEN pin
- ii. USBx_OVRCURA pin or USBx_OVRCURB pin



Sample Program using USB Host Communication Device Class Driver(HCDC) for USB Mini Firmware to communicate via USB with CDC device

Property	Value
> 🏶 Configurations	
✓ I Resources	
🗸 💷 USB	
VISB0_HOST	
🛰 USB0_VBUSEN Pin	Used
🛰 USB0_OVRCURA Pin	Used
🛰 USB0_OVRCURB Pin	Unused
✓	
🛰 USB0_VBUS Pin	Unused

c. r_usb_hcdc_mini

Refer to chapter "Configuration" in USB Host Communications Devices Class Driver (HCDC) for USB Mini Firmware Firmware Integration Technology application note (Document number: R01AN2167).

3. Pin Setting (Select "Pins" tab)

Select the port for USB pin match the user system.

Type filter text		type filter t	ext (* = any string,	? = any character)	All	
🔋 RIICO	^	Enabled	Function	Assignment	Pin Number	Direction
Serial peripheral interface			USB0_DM	Not assigned	Not assigned	None
RSPI0			USB0_DP	Not assigned	Not assigned	None
() Serial sound interface			USB0_EXICEN	Not assigned	Not assigned	None
* CAN module			USB0_ID	Not assigned	Not assigned	None
* SD host interface			USB0_OVRCURA	P14/MTIOC3A/MTCLKA/TMRI2/TIOCB5/TCLKA/C	/ 32	1
USB 2.0 host/function modul			USB0_OVRCURB	Not assigned	Not assigned	None
 4 12-bit A/D converter 6 613AD0 			USB0_VBUS	Not assigned	Not assigned	None
S12AD0		\checkmark	USB0_VBUSEN	P32/MTIOC0C/TMO3/TIOCC0/RTCOUT/RTCIC2/T	/ 18	0
🙀 12-bit D/A converter			VCC_USB	VCC_USB	35	-

4. Generate Code

The Smart Configurator genrates source codes for USB FIT module and USB pin setting in "*ProjectDir*>*¥src¥smc gen*" folder by by clicking on the [100 (Generate Code)] button.

🏟 *usb_prj.scfg 🛛	- 8
Software component configuration	1
Compon $\downarrow_Z^a \square \blacksquare \Rightarrow \bullet$ Configure	

Note:

Select "Yes" if the following dialog box is displayed.

?	Current section setting of project may not be compatible with Smart Configurator Do you want to change section setting?
-	Current section setting:
	B 1.R 1.B 2.R 2.B.R.SU.SI/4.PResetPRG/FFC00000.C 1.C 2.C.C\$DSEC.C\$BSEC.C\$INIT.
	\$VTBL,C\$VECT,D_1,D_2,D,P,PIntPRG,W_1,W_2,W,L/FFC00100,EXCEPTVECT/FFFFF80,
	RESETVECT/FFFFFFC
	New section setting:
	SI,SURI_STACK,B*,R*/0x00000004,INTERRUPT_VECTOR,P*,C*,D*,W*,L/0xFFC00000,FIX INTERRUPT_VECTOR/0xFFFFF80
	[Yes] to change section setting
	[No] to keep current section setting
	[Cancel] to cancel code generation
	[cance] to cancel code generation



6.3 Add the application program and the configuration file

- 1. Copy the *demo src* folder in this package to the "<*ProjectDir*>¥src" folder.
- 2. Copy the RI600V4 configuration file (.cfg file) to "<*ProjectDir*>" folder.
- 3. Select "File" in the "Project Tree" and click the right button. Select [Add] → [Add New Category] and create the category to store the application program. Then select [Add File] and register the application program and the configuration file which are copied at the above 2.

ц.	Project Tree 📮 🗶	Property	- x
Smart Manual	2 🕜 🙎 🗷	File Property	a p -+
1	⊡ – 🕂 <u>rx_usb (Project)*</u>	▲ Build	
nua		Set as build-target Yes	
Ð	📖 Smart Configurator (Design Tool)	File type C source	
	🔨 CC-RX (Build Tool)	Set individual compile option	
	RI600V4 (Realtime OS)		
	RX Simulator (Debug Tool)		
	Program Analyzer (Analyze Tool)		
	FIL		
	Add	Add File	
	🖮 🚽 😰 Open Folder with Explorer	1 Add New File	
	Windows Explorer Menu	Add New Category	
	B Pamous from Droiset Chift	· Dal	

Note:

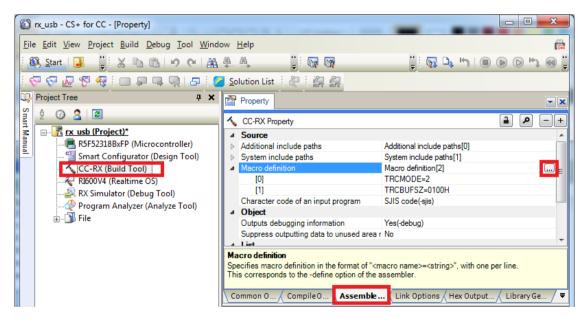
Remove the "task.c" file and "sample.cfg" created in "<ProjectDir>" folder by CS+.

6.4 Remote Macro Definition

Remove these macros since the following macros is defined in the new created project.

Select [CC-RX(Build Tool)] \rightarrow [Assemble Options] tab, remove the following macros.

- 1. TRCMODE = 2
- 2. TRCBUFSZ = 0100H



6.5 Build Execution

Excecute the build and generate the binary target program.

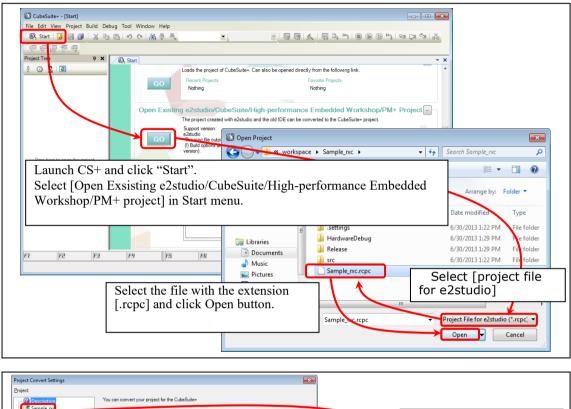


7. Using the e² studio project with CS+

The HCDC contains a project only for e^2 studio. When you use the HCDC with CS+, import the project to CS+ by following procedures.

[Note]

- 1. Uncheck the checkbox Backup the project composition files after conversion in Project Convert Settings window.
- 2. The following method is not supported when using RI600V4. Refer to chapter **6**, Using RI600V4 project with CS+.



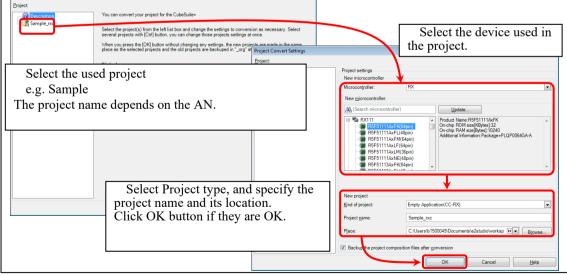


Figure 7-1 Using the e² studio project with CS+

Website and Support

Renesas Electronics Website http://www.renesas.com/

Inquiries

http://www.renesas.com/inquiry/

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Revision Record

		Descri	ption
Rev.	Date	Page	Summary
1.00	Dec 1, 2014	—	First Edition Issued.
1.01	Jun 1, 2015	—	RX231 is added in Target Device.
1.02	Dec 28, 2015	—	Upgrading of this USB driver by upgrading of "USB Basic Mini Firmware (R01AN2166)".
1.10	Nov 30, 2018	_	 The following chapter has beed added. 3.1.2 RSK/RSSK Setting The following chapter has beed changed. 4. Sample Application
1.12	Jun 30, 2019		RX23W is added in Target Device.
1.20	Jun 1, 2020	—	Supported the real-time OS.

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Handling of Unused Pins

Handle unused pins in accordance with the directions given under Handling of Unused Pins in the manual.

— The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
 - In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.

In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

- The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.
- 4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

- When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.
- 5. Differences between Products

Before changing from one product to another, i.e. to a product with a different part number, confirm that the change will not lead to problems.

The characteristics of Microprocessing unit or Microcontroller unit products in the same group but having a different part number may differ in terms of the internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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